

Thermal Grease 21-460

Preliminary 201027B

Technical Data Sheet

Description

Jones 21-460 is a thermal interface material developed with high thermal conductivity and low thermal resistance. Good heat dissipation making this a popular choice for high watt density chips like CPUs, GPUs, ASICS, Northbridge chipsets and heat sink.

Jones 21-460 can be easily screen printed and stenciled onto the heat sink or heat spreader. It also provide outstanding reliability while remaining stable through all industry standard reliability testing.



Benefits

Applications

ASICS Chips

GPUs

Excellent Thermal Resistance

 CPUs (Notebooks, PCs, Servers) LED Solid State Lighting

High Thermal Conductivity

Low Viscosity Allows Easy Application

RoHs 2.0 Compliant

Standard Package

Storage Conditions

Supplied in the package of 1kg.

Temperature < 28℃ RH 50% * Unopened Original Package

Declaimers

• The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the issuing date of this TDS. When using our products, no matter what type of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this TDS are subject to change without prior notice.

• Do not use the products beyond the specifications described in this TDS. This TDS explains the typical performance of the products as individual component. Before use, check and evaluate their operations when installed in your products.

• Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other significant damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention equipment.

> JONES TECH PLC 3 Dong Huan Zhong Road, BDA, Beijing 100176 China TEL: +86 10 6786 2636 FAX: +86 10 67860291 E-mail: sales@jones-corp.com





Specifications

PROPERTIES		JONES 21-460	TEST METHOD
Thermal	Thermal Conductivity (W/mK)	6.0	HOT DISK
	Thermal Resistance @40 psi (cm^2°C/W)	0.062	ASTM D5470
	Service Temperature (°C)	-40~125	JONES
Phisical	Techonology	Silicone	-
	Color	Grey	Visual
	Viscosity (Pa·s)	690	ASTM D2196
	Density @25°C (g/cc)	2.4	ASTM D792
Regulatory	Flame Rating	V0	UL 94
	Shelf Life @25°C (Months)	6	JONES
	RoHs Compliant	YES	-

Thermal Resistance vs Pressure